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the United States Postal Service as "Express Patent Application, Assistant Commissioner"

Attorney Doc. #: 67,200-674
Mailing Date: Feb. 7, 2002

Transmitted herewith for filing is the patent application of:

Inventor(s): Hsien-Hua Tseng Chia-Hung Chung

For: Wafer Transport Pod With Linear Door Opening Mechanism

Submitted herewith are:

X 2 sheets of formal drawings showing Figs 1-4B

✓X An Assignment of the invention to Taiwan Semiconductor Manufacturing Co., Ltd., together with Assignment Recordal Sheet

X A Declaration for patent application under CFR 1.63 and 1.68

The filing fee has been calculated as shown below:

	No. Filed	No. Extra	Small Entity Fee	Large Entity Fee	Total
Basic Fee			\$370.00	\$740.00	\$740.00
Total Claims	12x20	0 x	\$9.00	\$18.00	\$0
Indep. Claims	2 -3	0 x	\$42.00	\$84.00	\$0
Multiple Dep. Clms.			\$140.00	\$280.00	\$0
Assign. Rec. Fee			\$40.00	\$40.00	\$40.00
TOTAL					\$780.00

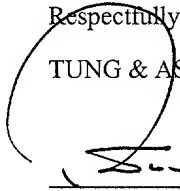
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- ☒ Attached is a Credit Card Payment Form for the sum of \$ 780.00
- ☒ Charge Visa Credit Card No. 4756 8461 9568 0263 the sum of \$ 780.00
A duplicate copy of this transmittal is attached.
- ☒ The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Visa Credit Card No. 4756 8461 9568 0263.
A duplicate copy of this sheet is enclosed.
- ☒ Any additional filing fees required under 37 CFR 1.6
☒ Any patent application processing fees under 37 CFR 1.17

Respectfully submitted,

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RWT/kd
Enclosures